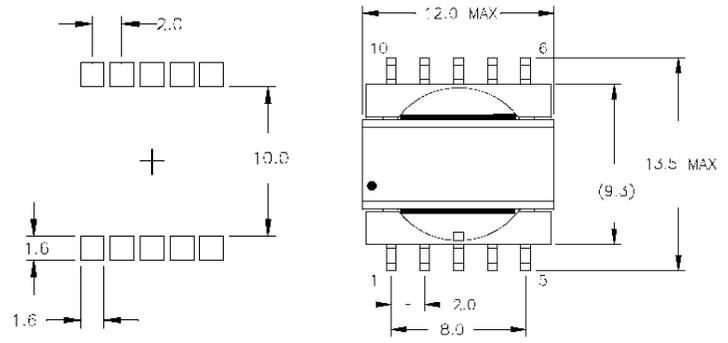
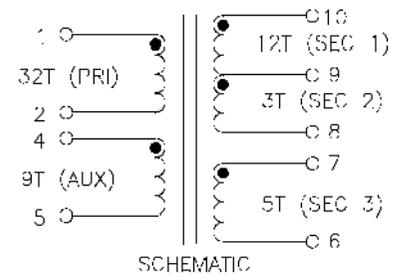
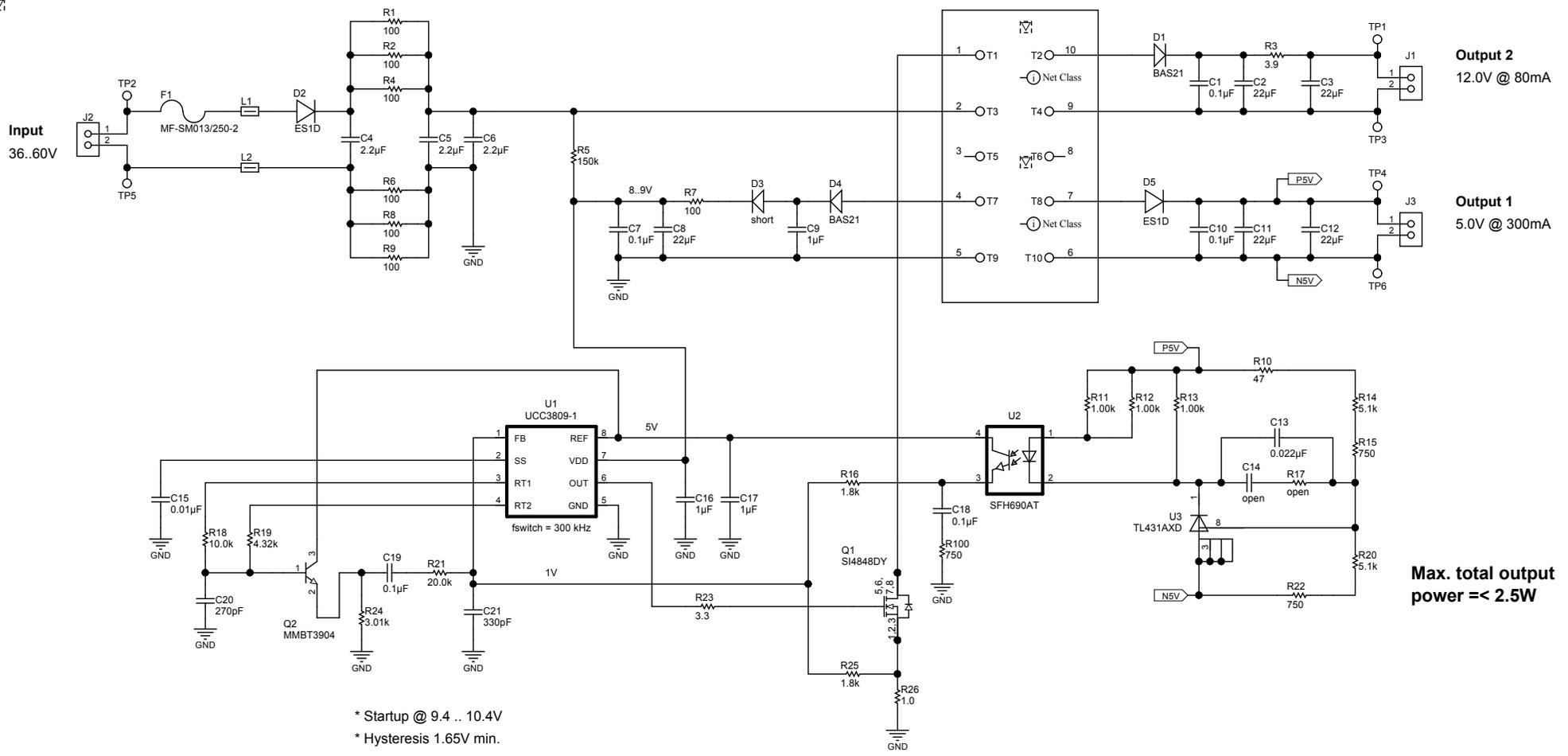


Revision History	
Revision	Notes
A	* First release
B	* Built & Tested, PCB PMP8580 Rev.A



Turns Ratio
 (1-2):(10-9) = 2.67
 (1-2):(9-8) = 10.67
 (1-2):(7-6) = 6.4
 (1-2):(4-5) = 3.56
 (1-2) = 500uH

- Assembly Notes**
- * Short D3
 - * D5 does not fit on footprint (SOT-23)
 - * R100 has no footprint
 - * Do not populate C14, R17



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